

TECHCON 2011 Session Chairs, Vice Chairs, Judges

Monday, September 12, 2011					
		Session 1: Test and Testability	Session 2 Analog, Mixed-Signal and RF Circuit Design	Session 3 Graphene	Session 4a Dielectric Material Robustness
8:00 AM	Chair	Nilanjan Mukherjee, Mentor Graphics	Yanli Fan, Texas Instruments	Luigi Colombo, Texas Instruments	Seung-Hyun Rhee, GLOBALFOUNDRIES
	Vice-Chair	William Joyner, SRC	Amlan Ghosh, IBM	Zoran Krivokapic, GLOBALFOUNDRIES	Jon Candelaria, SRC
	Judges	LeRoy Winemberg, Freescale	David Onsongo, IBM	Luigi Colombo, Texas Instruments	Adrien Lavoie, Novellus
		Jason Rivers, Advanced Micro Devices	Baher Haroun, Texas Instruments	C-Y Sung, IBM	Eric Lee, TEL
		John Carulli, Texas Instruments	John Pigott, Freescale	Zoran Krivokapic, GLOBALFOUNDRIES	
		Priyadarsan Patra, Intel	Ramon Mangaser, Advanced Micro Devices	Tom Kazior, Raytheon	
					Session 4b Logic Devices
	Chair				C-P Chang, Applied Materials
	Vice-Chair				Kwok Ng, SRC
	Judges				Niti Goel, Intel
					Witek Maszara, GLOBALFOUNDRIES
					Robert Clark, TEL
10:40-12:10		TechFair 1			
12:10-1:10		Lunch			
		Session 5 Design Flows and Tools	Session 6 Digital Circuits	Session 7 Interconnect Scaling	Session 8a Topological Systems and Quantum Effects
1:10 PM	Chair	Will Conley, Freescale	Keith Kasprak, Advanced Micro Devices	Andy Antonelli, Novellus	George Bourianoff, Intel
	Vice Chair	William Joyner, SRC	David Yeh, SRC	Jeff Bielefeld, Intel	Tom Kazior, Raytheon
	Judges	Savithri Sundareswaran, Freescale	Rasit Topaloglu, GLOBALFOUNDRIES	Seung-Hyun Rhee, GLOBALFOUNDRIES	George Bourianoff, Intel
		Mahesh Sharma, Advanced Micro Devices	Rahul Rao, IBM	Mehul Naik, Applied Materials	Zoran Krivokapic, GLOBALFOUNDRIES
		David Onsongo, IBM	Jim Feddeler, Freescale	Roey Shaviv, Novellus	Tom Kazior, Raytheon
		Juan Rey, Mentor Graphics	Kim Eckert, Advanced Micro Devices	Michael Su, Advanced Micro Devices	
		Shishpal Rawat, Intel	Russell Schreiber, Advanced Micro Devices	Dan Edelstein, IBM	
					Session 8b Advanced Patterning
	Chair				Pawitter Mangat, GLOBALFOUNDRIES
	Vice-Chair				Ben Rathack, TEL
	Judges				Pawitter Mangat, GLOBALFOUNDRIES
					Ben Rathack, TEL
					Nicholas Eib, GLOBALFOUNDRIES
		URO Poster Judges	ERI Poster Judges		
		Celia Merzbacher, SRC	Bob Havemann, SRC		
		Betsy Weitzman, SRC	Ralph Cavin, SRC		
		Jeff Welsler, IBM			
3:50 - 5:20		TechFair 2			

TECHCON 2011 Session Chairs, Vice Chairs, Judges

Tuesday, September 13, 2011

		Session 9 Multicore Design	Session 10A Design and Test of 3D Circuits	Session 11a Green High Performance Materials	Session 12a Modeling and Analog Devices
8:00 AM	Chair	Jim Holt, Freescale	Rasit Topaloglu, GLOBALFOUNDRIES	Allen Bowling, Texas Instruments	Jeff Smith, Texas Instruments
	Vice Chair	David Yeh, SRC	William Joyner, SRC	Ian Brown, TEL	Kwok Ng, SRC
	Judges	Fernando Mujica, Texas Instruments	Roberto Suaya, Mentor Graphics	Allen Bowling, Texas Instruments	Surya Veeraraghavan, Freescale
		Mike O'Conner, Advanced Micro Devices	Tom Vrotsos, Texas Instruments	Ian Brown, TEL	Rick Wise, Texas Instruments
		Robert Nguyen, Intel	Bill Read, Freescale	Marie Burnham, Freescale	
			Yaping Zhan, Advanced Micro Devices		
		Session 10b 3D Circuits	Session 11b ESH Impact and Assessment	Session 12b Memory Devices	
	Chair		Darvin Edwards, Texas Instruments	Allen Bowling, Texas Instruments	Horacio Gasquet, Freescale
	Vice Chair		Jon Candelaria, SRC	Ian Brown, TEL	Kwok Ng, SRC
	Judges		Ravi Mahajan, Intel	Allen Bowling, Texas Instruments	Surya Veeraraghavan, Freescale
			Jeff Cunningham, Freescale	Ian Brown, TEL	Xiaodong Yang, GLOBALFOUNDRIES
			Mark Morgan, Texas Instruments	Marie Burnham, Freescale	Feng Zhou/Freescale
10:40-12:10		TechFair 3			
12:10-1:10		Lunch			
		Session 13a Design and Analysis Tools	Session 14 Integrated System Design	Session 15a Packaging Materials	Session 16a Graphene Devices
1:10 PM	Chair	Sani Nassif, IBM	Marco Corsi, Texas Instruments	Mike Shapiro, IBM	Kim Reid, TEL
	Vice Chair	Dale Edwards, SRC	David Yeh, SRC	Jon Candelaria, SRC	Kwok Ng, SRC
	Judges	David Burnett, Freescale	Gary Morrison, Freescale	Akif Sultan, GLOBALFOUNDRIES	C-P Chang, Applied Materials
		David Newmark, Advanced Micro Devices	Thomas Teel, Advanced Micro Devices	John Dukovic, Applied Materials	Bob Miller, GLOBALFOUNDRIES
		Lawrence Arledge, Texas Instruments	Shishpal Rawat, Intel	Pat Thompson, Texas Instruments	Tom Kazior, Raytheon
		Session 13b Verification	Session 15b 3D Applications and TSVs	Session 16b Magnetic Devices	
	Chair	Viresh Paruthi, IBM		Michael Su, Advanced Micro Devices	Kim Reid, TEL
	Vice Chair	William Joyner, SRC		Jon Candelaria, SRC	Kwok Ng, SRC
	Judges	Jay Bhadra, Freescale		Seung-Hyun Rhee, GLOBALFOUNDRIES	Bob Miller, GLOBALFOUNDRIES
			Jason Baumgartner, IBM		Varughese Mathew, Freescale
		Robert Nguyen, Intel		Bruce Altemus, TEL	Feng Zhou/Freescale
		URO Poster Judges	ERI Poster Judges		
		Celia Merzbacher, SRC	Bob Havemann, SRC		
		Betsy Weitzman, SRC	Ralph Cavin, SRC		
		Jeff Welsler, IBM			
3:50 - 5:20		TechFair 4			